

Rapid Simulations of Hyperspectral Near-field Images of Three-dimensional Heterogeneous Surfaces -- Part II

XINZHONG CHEN^{1*}, ZIHENG YAO¹, ZHIYUAN SUN², STEFAN G. STANCIU³, D. N. BASOV⁴, RAINER HILLENBRAND^{5,6}, MENGKUN LIU^{1,7*}

¹Department of Physics and Astronomy, Stony Brook University, Stony Brook, New York 11794, USA

²Department of Physics, Harvard University, Cambridge, Massachusetts 02138, USA

³Center for Microscopy-Microanalysis and Information Processing, Politehnica University of Bucharest, 060042, Romania

⁴Department of Physics, Columbia University, New York, New York 10027, USA

⁵CIC nanoGUNE BRTA and Department of Electricity and Electronics, EHU/UPV, Donostia-San Sebastian 20018, Spain

⁶IKERBASQUE, Basque Foundation for Science, Bilbao 48011, Spain

⁷National Synchrotron Light Source II, Brookhaven National Laboratory, Upton, New York 11973, USA

*xinzhong.chen@stonybrook.edu, mengkun.liu@stonybrook.edu.

Abstract: The modeling of the near-field interaction in the scattering-type scanning near-field optical microscope (s-SNOM) is rapidly advancing, although an accurate yet versatile modeling framework that can be easily adapted to various complex situations is still lacking. In this work, we propose a time-efficient numerical scheme in the quasi-electrostatic limit to capture the tip-sample interaction in the near field. This method considers an extended tip geometry, which is a significant advantage compared to the previously reported method based on the point-dipole approximation. Using this formalism, we investigate, among others, nontrivial questions such as uniaxial and biaxial anisotropy in the near-field interaction, the relationship between various experimental parameters (e.g. tip radius, tapping amplitude, etc.), and the tip-dependent spatial resolution. The demonstrated method further sheds light on the understanding of the contrast mechanism in s-SNOM imaging and spectroscopy, while also representing a valuable platform for future quantitative analysis of the experimental observations.

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1. Introduction

Near-field optics circumvents the diffraction limit by introducing a sharp probe tip to the proximity of the investigated sample specimen[1]. The high-momentum photon in the near-field zone is the necessary ingredient to gain deep subwavelength spatial resolution. In the modern scattering-type scanning near-field optical microscopy (s-SNOM)[2–4], the probe tip is polarized by the incident light, inducing a strongly enhanced field intensity at the apex of the tip, which interacts with the sample underneath. This interaction further modifies the amplitude and phase of the field scattered by the tip. The detected scattered field in the far-field zone can then be used to infer complex material properties with deep subwavelength spatial resolution.

In any imaging or spectroscopic experiment, establishing a concrete understanding of the signal contrast mechanism is the cornerstone for quantitative information extraction from the raw data. This is deemed a challenging task in s-SNOM due to the nontrivial electrodynamic interaction between the light, the nano-sized tip, and the sample material in the near-field zone[5]. Because of the difficulty in modeling the irregular shape of the tip, idealization is often inevitable. Based on this idea, numerous successful models with different complexities have emerged over the past two decades as solutions to explain and analyze the s-SNOM contrast. Prominent examples include the point-dipole model[6,7], the finite-dipole model[8], the lightning-rod model[9], and a few others[10,11]. Furthermore, extensions of the models to account for more general

experimental conditions such as layered thin films[12–16] and anisotropic materials[17–20] have been proposed.

Recently we proposed a numerical framework that extends the original point-dipole model to surfaces with arbitrary topographic features and dielectric compositions[21]. Although the method demonstrates great merits and is time-efficient, it suffers from several drawbacks. For example, the point-dipole model is known to severely underestimate the penetration depth of the electric field due to the rapid decay of the dipole field[22]. This causes the discrepancy between the predicted spectra and the experimental measurements on thin films[22]. Secondly, the point-dipole model does not represent the realistic tip shape. When strong resonances occur in the sample material, the predicted spectral response often significantly deviates from the experimental measurement[8]. Therefore, the previous method welcomes improvements that can address such issues. In this article, we demonstrate an alternative to our previously reported method that is more advanced and efficient in explaining and modeling s-SNOM data. While exhibiting similar time efficiency with the initial method, the new version considers more realistic tip geometries which enables a wide palette of additional use cases, augmenting as well the applications that we previously discussed in detail in our past work[21]. As a proof-of-concept demonstration, we employ an elongated spheroid tip[10,23] to investigate various near-field phenomena such as the near-field interaction with biaxial and uniaxial materials, the dependence of the spatial resolution on various experimental parameters, and several other important issues that preoccupy the s-SNOM community.

2. Quasi-electrostatic simulations including the extended tip geometry

Electrodynamic simulations have led to fruitful results in the context of s-SNOM signal modeling[24–31]. However, the computationally intensive nature of the full-wave simulation prevents its wide use, with a limited number of applications having been reported. Simulating a near-field spectrum or image with a high spectral or spatial resolution is often impractical for commercial computers. On the other hand, it should be noticed that most analytical models are constructed under the quasi-electrostatic limit, where the incident wavelength is considered to be much larger than the tip and the probed region of interest on the sample. Although this approximation does not seem appropriate, especially in the visible and near-infrared (IR) regimes as the tip length is typically in the order of ten microns, it has been nonetheless shown that models under the quasi-electrostatic approximation capture the near-field physics very well especially in mid- and far-IR[6,8–10,32]. The prominent advantage of the quasi-electrostatic approximation is that it makes numerical simulations stable and time-efficient by only solving $-\nabla \cdot \nabla V = \rho_f$ with the appropriate boundary conditions[21]. Compared to its full-wave simulation counterpart, we find that our quasi-electrostatic simulation is at least one to two orders of magnitude faster. In addition, due to the absorption boundaries and small tip-sample distance used, full-wave simulations can often encounter convergence issue, which is not present in quasi-electrostatic simulations. We exploit these valuable features to set up a new s-SNOM simulation method that is described next in detail.

Various commercial and open-sourced Maxwell equations solvers such as COMSOL Multiphysics provide convenient platforms to conduct low-frequency electromagnetic simulations. To simulate the tip-sample near-field interaction in a quasi-static limit, the first step is to construct a uniform background excitation field E_i , which polarizes the tip and induces the field enhancement at the tip apex. As p-polarized light is predominantly used in the experiment and the elongated tip geometry yields a much larger polarizability in the tip shank direction, we only consider the vertical field and its dipole moment. The horizontal components can be considered in a similar fashion but not explicitly included in our current simulations. As schematically shown in Fig. 1(a), the uniform excitation field E_i can be generated by setting

the boundary conditions for the top and bottom surfaces as constant voltage $V = V_0$ and $V = 0$, similar to a parallel plate capacitor connected to a fixed voltage source. The tip and sample can be subsequently added into the simulation space. Commonly used tip geometries in the analytical models include elongated spheroid[8,10], hyperboloid[9], cone[11], and so on. We adopt a metallic elongated spheroid tip as an example throughout this work, but other tip configurations can also be used depending on the application of interest (See supplemental materials). The length of the spheroid is set as $L = 600$ nm in this study as we find this value to yield a good fit to the experimental data. In practice, L can be used as an empirical fitting parameter to capture the characteristics of the tip used in the experiments. The apex radius of curvature a relates to L and the width of the spheroid w by $a = \frac{w^2}{2L}$. By default, we use $a = 27$ nm, a dimension that aligns well to the size of common commercially available tips used for s-SNOM imaging. The appropriate mesh setting can be determined by checking the convergence while iteratively increasing the mesh density. We find that the convergence is ensured by setting the mesh size near the spheroid apex comparable to the tip-sample distance dz .

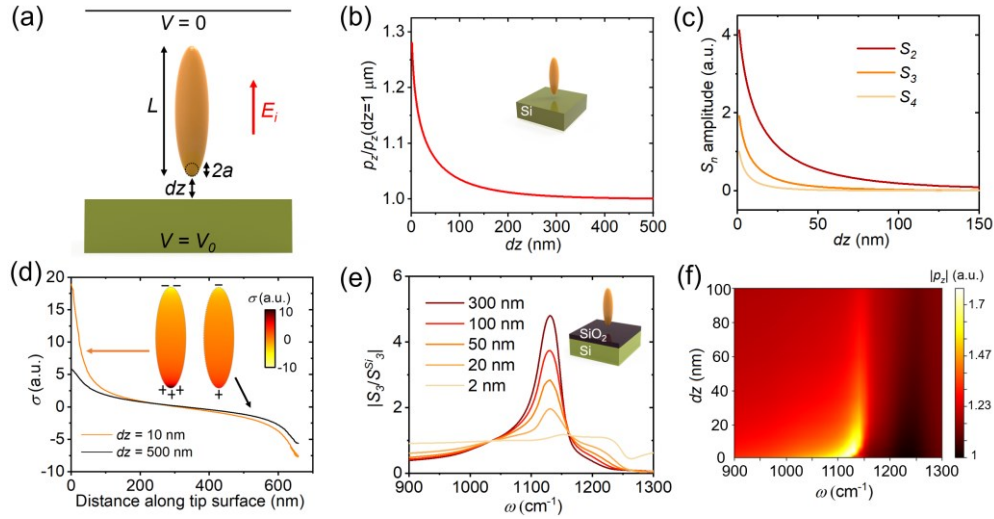


Fig. 1. (a) Schematics of the simulation setup. (b) The dipole moment of the spheroid on a Si sample as a function of tip-sample distance. (c) The corresponding approach curves demodulated at second, third, and fourth harmonics. Higher demodulation order exhibits a faster decay rate. (d) Surface charge density along the surface of the spheroid when it is 10 nm and 500 nm away from the Si surface. The inset shows the surface charge distributions. (e) Simulated near-field spectra of SiO₂ thin films of different thicknesses normalized to Si. (f) The amplitude of the dipole moment as a function of frequency and tip-sample distance for a 300 nm thick SiO₂ film on Si substrate.

Once the simulation is complete, we obtain the potential $V(x, y, z)$ and subsequently the electric field $\mathbf{E}(x, y, z)$. The dipole moment of the spheroid in the vertical direction can then be calculated by integrating the surface charge density σ over the spheroid surface

$$p_z \sim \oint \sigma z dS, \quad (1)$$

where $\sigma = \mathbf{E} \cdot \hat{\mathbf{n}}$ and $\hat{\mathbf{n}}$ is the surface unit normal vector. Finally, to mimic the tip oscillation and near-field modulation/demodulation processes, dz is discretized into ~ 10 points within the half cycle of the tip oscillation using a logarithmic spacing then interpolated to a finer grid for numerical integration (demodulation) as discussed before[21]. Assuming a harmonic oscillation of the tip $dz(t) = A(1 - \cos(\Omega t)) + h_0$, where A is the oscillation amplitude, Ω is the oscillation frequency, and h_0 is the minimal tip-sample distance, the experimentally collected demodulated signal is thus given by

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$$S_n = \int_0^T p_z(t) e^{-in\Omega t} dt, \quad (2)$$

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where $T = \frac{2\pi}{\Omega}$ and n is the demodulation order. It is important to realize that a multiplicative far-field factor due to secondary reflections off the sample surface is not considered in this simulation approach, similar to our previous simulation method[21]. This far-field factor can be either analytically calculated or numerically simulated in addition to the current simulation framework if needed[33] (See also supplemental materials). Although experimentally this multiplicative factor presents measurable effects in the data, recent works have demonstrated it can be effectively filtered by computing the ratio of near-field signals demodulated at different harmonics[34,35].

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Before performing elaborated simulations, we verify the validity of the method by means of simple examples. First, we simulate p_z as a function of the tip-sample distance dz on Si as shown in Fig. 1(b). The corresponding demodulated signals S_n (approach curves) are shown in Fig. 1(c). Both p_z and S_n exhibit rapid decay as the tip pulls away from the sample surface as expected. A higher demodulation order yields a faster decay rate, which is a well-known phenomenon[36–39]. Here we take a look at the surface charge distribution in the spheroid in two cases -- when it is interacting, or not, with the Si surface. The charge density σ on the spheroid surface along the vertical direction when $dz = 10$ nm and $dz = 500$ nm are shown in Fig. 1(d). When the spheroid is far away from the Si surface, the charge distribution is purely induced by the background field E_i . Therefore, the positive and negative charges exhibit a symmetry distribution toward both ends of the spheroid. When the spheroid is brought in the vicinity of the Si surface, the near-field interaction breaks the symmetry and causes a drastically higher charge density on the apex, which is responsible for the strong field enhancement as well as for the modified dipole moment.

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Next, we demonstrate the advantage of the proposed method compared to the previous point-dipole model framework[21]. In Fig. 1(e) we plot the broadband near-field amplitude spectra of SiO₂ thin films deposited on a Si substrate. The spectra are normalized to that on Si. The thickness t of the film varies from 300 nm to 2 nm. The simulated spectra show great consistency with the previously published experimental data (see also supplementary materials) while the point-dipole model prediction is noticeably worse[22]. This is because the point-dipole does not capture the effect of the extended tip shank very well while the elongated spheroid is a much superior approximation to the real conic or pyramidal tip. Since the measurement of thin films is ubiquitous in s-SNOM experiments[40–45], an accurate model for data analysis in this regard is indispensable. For reference, the simulation of one spectrum in Fig. 1(e) only took a few minutes using a common commercial desktop.

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Besides s-SNOM, the proposed simulation method can be readily adapted to simulate other optical scanning-probe measurements. For example, in Fig. 1(f) we show the amplitude of p_z as a function of dz and frequency ω for a 300 nm SiO₂ film on a Si substrate. This result is representative of the recently developed peak-force SNOM technique, where the vertical interaction can be reconstructed without the Lock-in demodulation of the scattering signal[38,46,47]. Other optical scanning probe techniques such as photo-induced force microscopy (PiFM)[48,49], photo-thermal-based techniques like AFM-IR[50–52], tip-enhanced photo-luminescence[53], and tip-enhanced techniques based on non-linear optical effects[54–56] could potentially benefit from similar simulations as well. For example, to simulate PiFM signal, one can evaluate the electric force on the tip due to the charge accumulation on the sample. To simulate AFM-IR contrast, the electromagnetic simulation needs to be coupled with heat transport simulation to determine the thermal expansion of the sample under near-field heating.

177 It should be noted that in the simulation, the background electric field E_i is not a constant when
 178 V_0 is set as a constant. This is due to the change of sample dielectric function or geometry. To
 179 illustrate this point let us consider an ideal parallel plate capacitor with a dielectric slab inside.
 180 The dielectric slab represents the sample in the simulation. Assume the spacing between the
 181 plates is $d_1 + d_2$. The thickness of the slab is d_2 . The relative dielectric function of the slab is
 182 ε . Continuity of D_\perp across the dielectric boundary leads to $\varepsilon_0 E_i = \varepsilon E_d$, where E_d is the field
 183 inside the dielectrics and $\varepsilon_0 = 1$ is the relative vacuum dielectric constant. Also, we have $V =$
 184 $E_i d_1 + E_d d_2$. Combining the two equations gives

$$185 \quad E_i = V / \left(\frac{d_1}{\varepsilon_0} + \frac{d_2}{\varepsilon} \right). \quad (3)$$

186 Since ε depends on the materials as well as the frequency, E_i is not a constant in the simulation.
 187 This change in the background field felt by the tip does not relate to the tip-sample near-field
 188 interaction and could be a source of artifact in the simulation. When the sample structure is
 189 planer layers, this effect can simply be normalized by setting a variable voltage $V_0 = E_i \left(\frac{d_1}{\varepsilon_0} + \right.$
 190 $\left. \frac{d_2}{\varepsilon} \right)$ on the simulation boundary, resulting in a constant E_i . It is also evident from equation 3
 191 that choosing a larger d_1 and smaller d_2 in the simulation will lead to a smaller variation in E_i
 192 when ε is changing. Considering the penetration depth of the electric field, d_2 should be at least
 193 hundreds of nm while d_1 can be made arbitrarily large. For multi-layered samples such as the
 194 SiO₂ thin films shown in Fig. 1(e), equation (3) can be generalized to include two or more
 195 dielectric slabs. When the sample does not take the form of uniform slabs and has topographic
 196 or compositional features, E_i is in general not spatially uniform. However, practically this
 197 effect is typically minor and only significant for ε close to 0. Furthermore, we can counter this
 198 effect to a certain extent by specifically designing a spatially varying $V_0(x, y, z)$. In all
 199 simulations demonstrated in this work, we correct the variation of E_i or make sure that the
 200 nonuniformity of E_i does not alter the results significantly. Note that the previously proposed
 201 simulation method based on the point-dipole model does not experience the same issue since
 202 the point-dipole can itself serve as a field source and thus no background field is required[21].
 203 Therefore, when simulating surfaces with complex topography or material composition, the
 204 previous method might be favorable.
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206 3. Near-field response of uniaxial and biaxial anisotropic materials

207 Most crystals naturally exhibit anisotropy due to the lattice symmetry. However, the
 208 incorporation of sample anisotropy in some models is difficult and mathematically
 209 cumbersome. This is the reason why the impact of sample anisotropy on the near-field
 210 scattering signal is still not thoroughly studied. One great advantage of our proposed method is
 211 that the full dielectric tensor can be straightforwardly included in the simulation. Next, we
 212 investigate the near-field response of uniaxial and biaxial anisotropic materials. An earlier
 213 experimental study investigated the dielectric response of mica flakes under 40 nm thin using
 214 broadband near-field spectroscopy (nano-FTIR). Using a multilayer finite-dipole model, the
 215 authors found that only the out-of-plane dielectric function contributes to the near-field spectra
 216 while the in-plane response in mica is not detectable. We attempt to test this finding using the
 217 spheroid tip in our simulation. The in-plane and out-of-plane dielectric functions of mica are
 218 directly obtained from the previous study[57] and input into the COMSOL simulations in the
 219 full tensor form. The simulated S_2 amplitude spectra for 40 nm, 7 nm, and 4 nm mica on Si
 220 substrate are consistent with the experimental data in [57] and shown in Fig. 2(a). Next, we
 221 closely examine the in-plane and out-of-plane responses individually. In Fig. 2(b) we show the
 222 calculated spectra of 40 nm mica on Si substrate. The three spectra are obtained using the full
 223 dielectric tensor, only the in-plane dielectric function, and only the out-of-plane dielectric
 224 function. Our result indicates that although only considering the out-of-plane component of the

dielectric tensor yields a similar result compared to considering the full tensor, the effect of the in-plane response is non-negligible at this sample thickness. For thinner films such as 4 nm mica on Si substrate, we find that indeed the out-of-plane response is dominant as shown in Fig. 2(c).

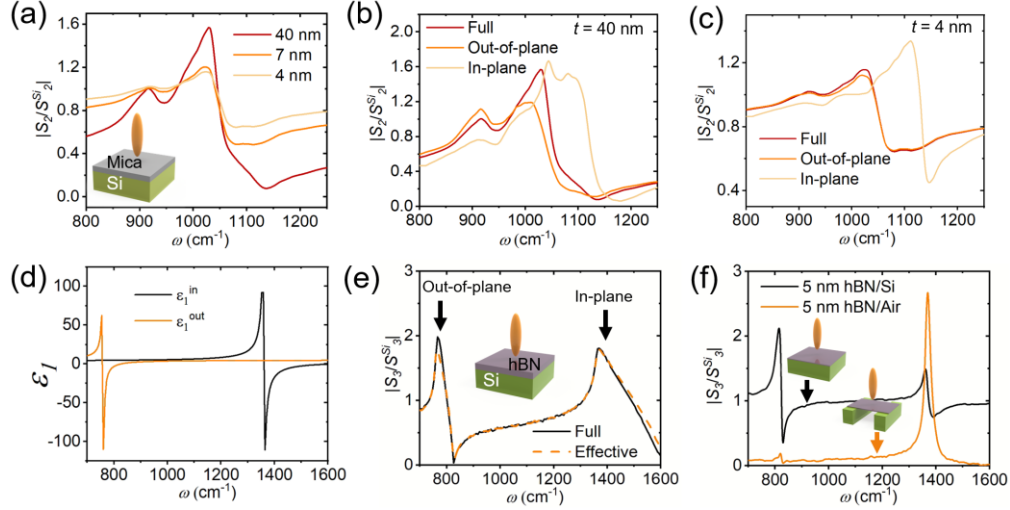


Fig. 2. (a) Simulated S_2 amplitude spectra of 40 nm, 7 nm, and 4 nm mica on Si substrate. (b) Simulated S_2 amplitude spectra of 40 nm mica on Si substrate considering the full dielectric tensor, only the out-of-plane dielectric function, and only the in-plane dielectric function. (c) Similar to (b) but for 4 nm mica. (d) In-plane and out-of-plane dielectric functions of hBN, showing distinctive phonon resonances. (e) S_3 amplitude spectra simulated for 300 nm thick hBN on a Si substrate considering the full dielectric tensor (solid curve) and the isotropic effective dielectric function (dashed curve). (f) S_3 amplitude spectra simulated for 5 nm thick hBN on a Si substrate (black curve) and 5 nm suspended hBN (orange curve).

This finding for mica is seemingly in conflict with the previous reports on graphene, where the in-plane response was found to be the dominant factor to the near-field signal contrast[15]. The noticeable difference between a thin layer of mica and graphene is that the optical conductivity of graphene, especially for doped variants, is orders of magnitude higher. Next we investigate how in-plane and out-of-plane responses contribute to the near-field signal using a prototypical material hexagonal boron nitride (hBN), where the in-plane and out-of-plane phonon resonances occur at distinctive frequencies, unlike mica or other anisotropic crystals such as sapphire. Fig. 2(d) shows the real part of the dielectric functions for the in-plane and out-of-plane directions of hBN[58], where the in-plane resonance occurs at a higher frequency (~ 1350 cm⁻¹) while the out-of-plane resonance at a higher frequency (~ 750 cm⁻¹) with comparable oscillator strength. It has been shown that an effective dielectric function $\epsilon_{eff} = \sqrt{\epsilon_{in}\epsilon_{out}}$, which is the geometric mean of the in-plane and out-of-plane dielectric functions provides a good approximation for the bulk sample[8,10]. This is the direct result of the method of image charge[59]. First we study the thick film case and simulate a 300 nm thick hBN on a Si substrate using the anisotropic dielectric tensor and compare that to the result using the effective dielectric function. The calculated S_3 amplitude spectra are shown in Fig. 2(e). Both the in-plane and the out-of-plane resonances show signatures in the near-field spectra. It is evident that considering the effective dielectric function indeed leads to a practically identical prediction compared to considering the full dielectric tensor. That is, for bulk samples or thick films, s-SNOM probing does not have a directional preference and the contributions from in-plane and out-of-plane dielectric responses are equal.

260 In the case of thin films, the effective dielectric function $\varepsilon_{eff} = \sqrt{\varepsilon_{in}\varepsilon_{out}}$ breaks down and the
 261 situation is more complicated. Not only the strengths of in-plane and out-of-plane responses of
 262 the film are important, but also the dielectric property of the substrate plays an important role
 263 as it can anisotropically screen the film response. This can be seen in Fig. 2(f), where S_3
 264 amplitude spectra are simulated for 5 nm hBN on a Si substrate as well as for 5 nm suspended
 265 hBN. In the hBN/Si case, the in-plane resonance is suppressed while in the hBN/Air case the
 266 out-of-plane resonance is diminished. This behavior has a qualitative interpretation in terms of
 267 substrate screening. The tip-scattered field is related to the total dipole moment on the thin film
 268 and the substrate. On a high dielectric substrate with isotropic dielectric function ε_s , the dipoles
 269 are screened in such a way that horizontal dipoles are weakened by a factor of $f_h = \frac{2}{1+\varepsilon_s}$ while
 270 the vertical dipoles are enhanced by a factor of $f_v = \frac{2\varepsilon_s}{1+\varepsilon_s}$, as can be shown by the method of
 271 image charge. In the limit of $|\varepsilon_s| \gg 1$, one has $f_h = 0$ and $f_v = 2$. This is further verified by
 272 the form of the frequency- and momentum-dependent reflection coefficient of the
 273 structure[10,60,61]:

$$274 \quad r_p(\omega, q) = \frac{r_{p12} + e^{2ik_z d} r_{p23}}{1 + e^{2ik_z d} r_{p12} r_{p23}}, \quad (4)$$

275 where

$$276 \quad r_{p12} = \frac{1 - \sqrt{\varepsilon_{in}\varepsilon_{out}}}{1 + \sqrt{\varepsilon_{in}\varepsilon_{out}}} \quad (5) \text{ and}$$

$$277 \quad r_{p23} = \frac{\sqrt{\varepsilon_{in}\varepsilon_{out} - \varepsilon_s}}{\sqrt{\varepsilon_{in}\varepsilon_{out} + \varepsilon_s}}, \quad (6)$$

278 d is the thickness of the sample, and $k_z = q\sqrt{-\varepsilon_{in}/\varepsilon_{out}}$ is the z -direction momentum of the
 279 electric field inside the sample. Note that the reflection coefficient discussed here should not
 280 be confused with the far-field reflection for the multiplicative far-field factor discussed in the
 281 previous section. For the near-field tip-sample interaction, we are generally interested only
 282 in $r_p(\omega, q)$ with $q \sim a$. It is convenient to define the dimensionless polarizabilities χ_{in} and χ_{out}
 283 as $\varepsilon_{in} = 1 + \chi_{in}$ and $\varepsilon_{out} = 1 + \chi_{out}$. In the limits of thin film ($|k_z d| \ll 1$), high dielectric
 284 substrate ($\varepsilon_s \gg 1$) and weak sample response ($\chi_{in}, \chi_{out} \ll 1$), one has $r_p \approx r_{p0} \{-qd[(r_{p0} +$
 285 $1)\chi_{in} + (r_{p0} - 1)\chi_{out} + 2] + 1\} \rightarrow 2qd(1 - \chi_{out}) - 1$, where $r_{p0} = \frac{1 - \varepsilon_s}{1 + \varepsilon_s} \rightarrow -1$. Therefore,
 286 only the out-of-plane response contributes to the signal in this limit. To compare, if there is no
 287 substrate, one has $r_p \approx -\frac{1}{2}qd(\chi_{in} + \chi_{out})$ such that the in-plane and out-of-plane responses
 288 contribute equally. In general, one can evaluate the contribution from in- and out-of-plane
 289 responses by computing $r_p(\omega, q)$.

290 Furthermore, in models such as the point-dipole model[15,61] and the lightning-rod model[9],
 291 uniaxial materials with in-plane rotational symmetry can be incorporated by considering
 292 $r_p(\omega, q)$. However, with biaxial materials, the in-plane rotation symmetry is broken, which
 293 poses difficulty in the modeling efforts[19]. This is where our proposed method demonstrates
 294 superiority. As a concrete example, we consider the near-field response from the biaxial van
 295 der Waals material MoO₃. MoO₃ is known to host the unique anisotropic surface phonon
 296 polaritons in the mid-IR and THz regimes, which have attracted tremendous research
 297 interest[23,62,63]. The dielectric function of MoO₃ in the relevant frequency range can be
 298 obtained from [64]. We first consider a 100 nm MoO₃ slab on a Si substrate and simulate the
 299 electric field distribution at various characteristic frequencies. As shown in Fig. 3(a),
 300 unidirectional polariton propagation in the crystal [100] and [001] directions are observed in
 301 740 cm⁻¹ and 915 cm⁻¹, while elliptical polariton waveform emerges at 985 cm⁻¹. The biaxial
 302 anisotropic is responsible for this unique signature of MoO₃. Next we demonstrate the

simulation of the near-field spectrum of MoO₃. 100 nm, 30 nm, and 10 nm MoO₃ slabs on a Si substrate are simulated. The amplitude and phase spectra are shown in Fig. 3(b) and (c). The ability to simulate subtle spectral responses of biaxial materials is the key to the extraction of quantitative information from near-field measurements. Besides spectral domain, the near-field response in real space is another interesting aspect especially when polariton occurs. Here we demonstrate that our method is suitable to study real-space phenomena such as the edge-launched polaritons. We simulate a line scan in the [100] direction across the edge of a 250 nm MoO₃ on a Si substrate at 930 cm⁻¹. p_z as a function of distance to the edge x and dz is shown in Fig. 3(d). The demodulated near-field response $|S_2|$ is shown as the black curve, where clear periodic oscillation is observed. Compared to the calculated phonon polariton dispersion (inset of Fig. 3(d)), we find that the periodicity exactly matches the phonon polariton wavelength, which indicates that the observed oscillation occurs due to the edge-launched polariton instead of the tip-launched one. This is due to the fact that the tip radius (27 nm) is about one order-of-magnitude smaller than the polariton wavelength thus the momentum matching is inefficient.

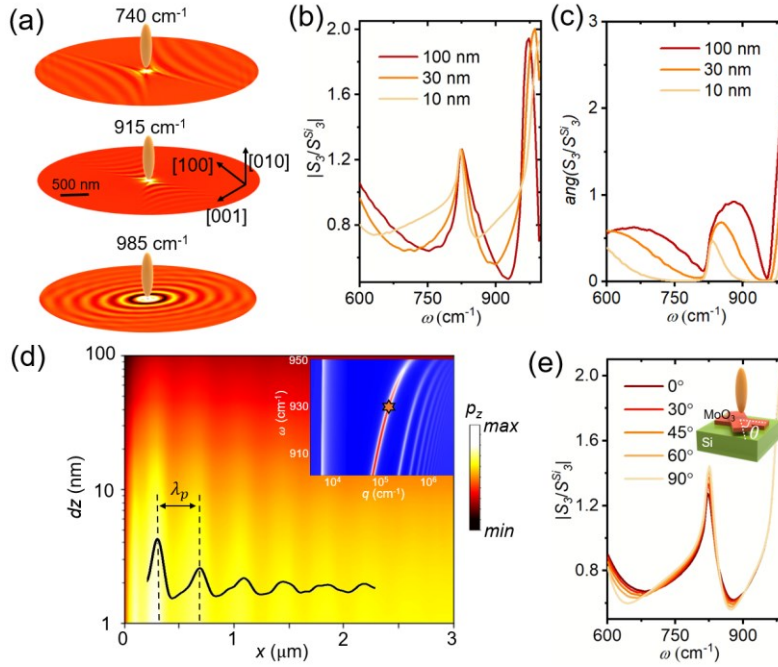


Fig. 3. (a) Electric field in the z-direction E_z simulated at 740 cm⁻¹, 915 cm⁻¹, and 985 cm⁻¹, where different polariton propagation directions due to the biaxial anisotropy are observed. (b) and (c) Simulated S_3 amplitude and phase spectra for 100 nm, 30 nm, and 10 nm MoO₃ slabs on Si substrate. (d) Simulated p_z as a function of dz during a line scan across the edge of a 250 nm thick MoO₃ slab on Si substrate at 930 cm⁻¹. The black curve shows the corresponding amplitude of S_2 , where oscillation with λ_p period corresponding to the edge-launched phonon polariton is observed. The inset depicts the dispersion of the phonon polariton calculated by the imaginary part of the reflection coefficient $Im(r_p)$. The star marks the observed frequency and momentum in the simulation. (e) Simulated S_3 amplitude spectra on two 10 nm MoO₃ slabs with a relative twist angle of 0°, 30°, 45°, 60°, and 90°.

In addition, topological transitions of polariton dispersion were recently observed in twisted MoO₃ slabs[65–67], making these a unique platform for investigating interesting physics and applications. This complex system again poses tremendous difficulties with respect to conventional modeling endeavors while our method can characterize the twisted layer in a facile manner. Next we demonstrate the spectra as a function of the twist angle θ in Fig. 3(e). The twisted layer can be characterized by a non-diagonal dielectric tensor $\epsilon_{twist} = R^T \epsilon_{MoO_3} R$, where ϵ_{MoO_3} is the diagonal dielectric tensor of MoO₃, R is the rotation matrix, and R^T is the transpose of R . Small yet systematic changes are observed for θ from 0° to 90°. Note that this

effect is intrinsically near-field, not to confuse with the far-field factor. The possibility to accurately simulate the spectral details is of paramount importance in delicate systems like this and other 2D material heterostructures. Our method provides a quantitative and versatile modeling approach for characterizing the spectrum of arbitrary materials, which is an important step for the quantitative analysis of near-field data.

It is worth noting again that in our simulation, the multiplicative far-field factor is not explicitly included. The spectral feature is purely due to the tip-sample near-field interaction. When an anisotropic sample is present, the anisotropy can also manifest itself via the far-field reflection off the sample surface, where the angle of incidence could be of significant importance and should be carefully addressed.

4. Experimental factors for the lateral resolution

Besides the flexibility it provides for incorporating different material properties, another major advantage of our numerical approach is the ability to consider the topographic and compositional inhomogeneities and simulate near-field images and line scans, a task usually very difficult with conventional analytical models. We demonstrate the utility of our method in this regard through the investigation of the lateral resolution in s-SNOM. A previous study employing both experimental works and full-wave simulations shows that, contrary to common beliefs, the resolution of THz s-SNOM does not simply scale with the tip apex radius linearly[27]. Instead, blunter tips yield a much larger scattering signal while still preserving a reasonable resolution. This makes blunter tips a better option than sharper tips considering the fact that THz light sources typically emit at low power. Here we shed additional light on this problem by employing our proposed methodology.

First we simulate the near-field signal line profile as the tip scans over a metal (Au)-dielectric (Si) interface. To avoid topography-related complications, the interface is designed to be flat as schematically shown in the inset of Fig. 4(a). Simulated S_n amplitude profiles for $n = 1, 2, \dots, 8$ are shown as the dots in Fig. 4(a). The profiles are fitted by the arctan function proposed in [27]. The best fits are shown as solid curves in Fig. 4(a) and the fitting parameters provide a quantitative estimate for the lateral resolution[27]. Fig. 4(b) demonstrates the lateral resolution determined from fitting for different demodulation orders using different tip radii ranging from 10 nm to 200 nm. The tapping amplitude is kept constant at 50 nm in all simulations. The general trend points to the fact that higher demodulation leads to a sharper boundary profile. This is because the lateral extension of the field modulated at higher harmonics is increasingly more confined[24]. More importantly, comparing 200 nm tip radius to 10 nm tip radius, we can see that although the tip radius is 20 times larger, the resolution is only worsened by a factor of less than 3. Importantly, the relative signal contrast as well as the raw scattering intensity are observed to increase along with the tip radius (Fig. 4(c)). These observations are highly consistent with the findings of the previous reports involving both experimental work and sophisticated full-wave simulations[24,27,28], which further validates the efficiency and accuracy of our simulations method based on quasi-electrostatics.

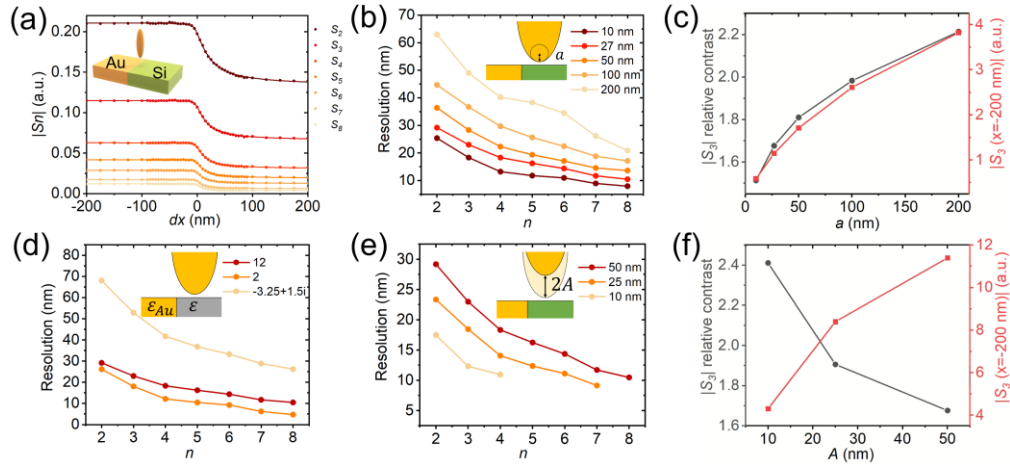


Fig. 4. (a) Simulated line profiles of S_n amplitude as the sphere scans over the Au and Si interface. The tip radius is 27 nm. (b) The lateral resolution obtained from fitting for different tip radii and demodulation order. (c) Relative contrast and absolute signal intensity on Au for S_3 amplitude as a function of tip radius. (d) The lateral resolution obtained from fitting for different material boundaries. The results include Au-Si ($\epsilon = 12$) boundary at 1000 cm^{-1} , Au-PMMA ($\epsilon = 2$) boundary at 1500 cm^{-1} , and Au-SiO₂ ($\epsilon = -3.25 + 1.5i$) boundary at 1130 cm^{-1} . (e) Lateral resolution obtained from fitting for different tip oscillation amplitudes. (f) Relative contrast and absolute signal intensity on Au for S_3 amplitude as a function of the tip oscillation amplitude.

The time-efficient nature of the simulations enables us to systematically study other contributing factors that account for the attainable resolution. Next we simulate the resolution dependence on material properties. More specifically, we study two additional interfaces: an Au-PMMA interface at 1500 cm^{-1} , where PMMA has a small dielectric constant ($\epsilon_{\text{PMMA}} = 2$) and an Au-SiO₂ interface at 1130 cm^{-1} , where the phonon polariton resonance occurs ($\epsilon_{\text{SiO}_2} = -3.25 + 1.5i$). The determined resolutions are plotted in Fig. 4(d) along with that from the previous Au-Si interface ($\epsilon_{\text{Si}} = 12$). Both tip radius (27 nm) and tapping amplitude (50 nm) are kept constant. Comparing the resolutions obtained for Au-Si and Au-PMMA, we can see that the resolution is slightly higher in the PMMA case due to the larger dielectric contrast. However, the resolution is drastically worse in the Au-SiO₂ case. We attribute the worsened resolution to the long-wavelength lossy phonon polariton in SiO₂, similar to the blurry boundary recently observed in WTe₂ due to the plasmon polariton[68]. The oscillation amplitude of the tip is another important factor that determines the achievable resolution. In Fig. 4(e) we study the resolutions obtained using different oscillation amplitudes. Smaller oscillation amplitude is found to improve resolution. However, when the oscillation amplitude is small, demodulation of the raw scattering signal to high harmonics of the tip oscillation frequency results in noisy data, which reduces the reliability of the fitting. Therefore, we only determine the resolution values up to the 7th harmonics for 25 nm tapping amplitude and the 3rd harmonics for 10 nm tapping amplitude. As shown in Fig. 4(f), although the relative contrast is higher when a smaller tapping amplitude is used, the raw signal intensity is lower.

To summarize our findings, higher demodulation order, smaller tip radius, larger contrast in dielectric function, and small tapping amplitude generally result in higher lateral resolution. However, in practice, higher resolution is usually not the only consideration. Raw signal intensity and signal contrast are often equally important because of the finite signal-to-noise ratio limited by the light source power, stability, and detector noise. Therefore, there is a fine balance in choosing the ideal experimental parameters. Identifying this optimal balance experimentally is cumbersome due to the typical signal integration times used in s-SNOM, and hence the image acquisition duration. Thus, our simulation method can be a valuable tool to help identify optimal experimental parameters for a particular s-SNOM application of interest.

Further on, we notice that the resolution and contrast determined from the flat material interface might not reflect other sample situations well. We prove this point by investigating a case where a small Au disk is embedded in a PMMA host, as schematically shown in the inset of Fig. 5(a). A simulated near-field S_3 amplitude image is shown in Fig. 4(e) using a tip radius of 27 nm and tapping amplitude of 50 nm. The line profile across the red dashed line is plotted in Fig. 5(b) together with several other profiles obtained using different tip radii. The trend is obviously very different from the flat interface case discussed previously, which is evident by the resolution and the relative contrast shown in Fig. 5(c). In the embedded small disk case, the resolution is observed to scale mostly linearly to the tip radius while the relative contrast drastically decreases when a large tip radius is used. This observation makes the larger tip radius highly unfavorable when imaging samples with small feature sizes. Based on the simulation results, we conclude that the ideal tip radius for a specific experiment depends on the characteristic size of the feature in the sample. A tip radius comparable in size to the feature of interest is the most optimal if both the resolution and the relative contrast are considered.

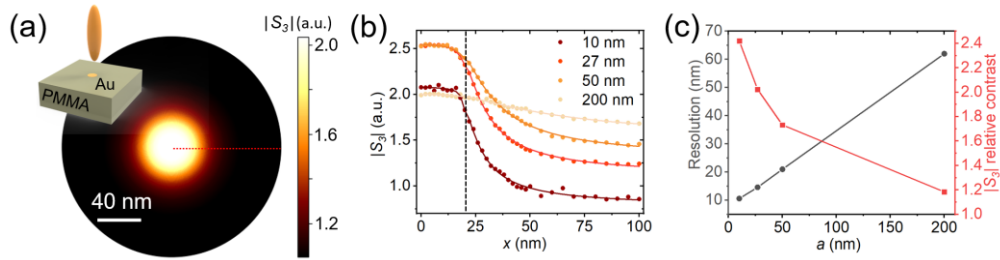


Fig. 5(a) Simulated S_3 amplitude image for a 20 nm radius Au disk embedded in PMMA. (b) Simulated line profiles of S_3 amplitude as the spheroid scans over the red dashed line in (a) for different tip radii. The vertical dashed line indicates the edge of the embedded disk. (c) Lateral resolution and relative contrast as a function of tip radius.

5. Conclusion and discussions

In this article, we propose a numerical method that is highly capable of accurately simulating the tip-sample interaction and tip scattering in s-SNOM experiments with tip geometry on demand. This method significantly augments the previously proposed simulation framework based on the point-dipole model[21]. The ability to consider the elongate tip shank provides a realistic prediction of the penetration depth of the electric field, which is important for analyzing spectra or images taken on layered thin films.

We use the proposed method to study anisotropic near-field interaction and find that for thick samples ($t > 300$ nm), s-SNOM is practically probing the geometric mean of the in-plane and out-of-plane dielectric functions. For thin samples ($t \sim 10$ nm), however, the near-field response is a complex mixture of in-plane and out-of-plane responses. Furthermore, our flexible method is able to account for biaxial anisotropy and even the presence of non-diagonal dielectric tensors, which is considered difficult in conventional analytical models.

The relations between the lateral resolution, signal contrast, raw signal intensity, and various external experimental parameters such as tip radius, demodulation orders, tapping amplitude are studied in greater depth. When the sample feature is much larger than the tip radius, a larger tip radius leads to stronger scattering intensity and larger material signal contrast while preserving a good lateral resolution. However, when the sample feature is small, e.g. nanoparticles, a larger tip radius becomes disadvantageous. Our simulations show that in this case the optimal tip radius is the one that is comparable to the feature size.

Due to the quasi-electrostatic nature of the simulation, retardation effects are ignored in our simulations. In certain situations these effects could play an important role[9,30], where full-wave simulations should be employed instead. A prominent example is when the incident light excites antenna resonances of the tip[69]. In this case, surface current forms standing wave, and a stronger field enhancement under the tip apex is realized. However, in most cases, our proposed method is demonstrated to be highly accurate, versatile, and easy to implement. It features several unique improvements over the previous methods and models. Therefore, we envision that it will become an important tool for future s-SNOM data analysis such as dielectric function extraction from spectroscopic or imaging measurements[14,70–72]. Given that the proposed method is highly time-efficient, it can also be regarded as a valuable tool to support future machine learning-related research[73–75] focused on s-SNOM and other optical techniques based on tip-enhancement, where a fast and reliable way to generate training data matching the experimental conditions of interest is crucial.

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Data availability. Data underlying the results presented in this paper are not publicly available at this time but may be obtained from the authors upon reasonable request.

Supplemental document. See [Supplement 1](#) for supporting content.

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